

General Description

This planar stripe MOSFET has better characteristics, such as fast switching time, low on resistance, low gate charge and excellent avalanche characteristics. It is mainly suitable for switching mode power supplies.

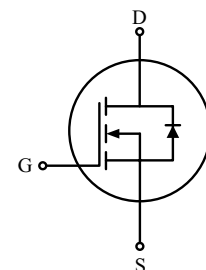
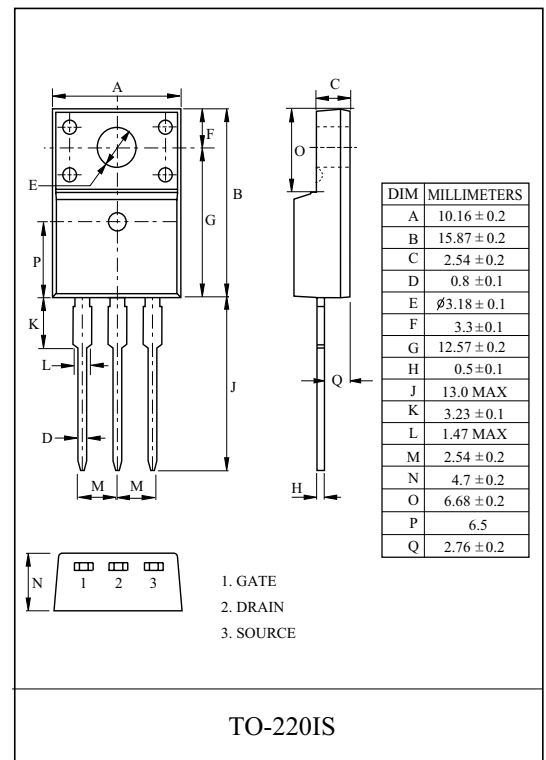
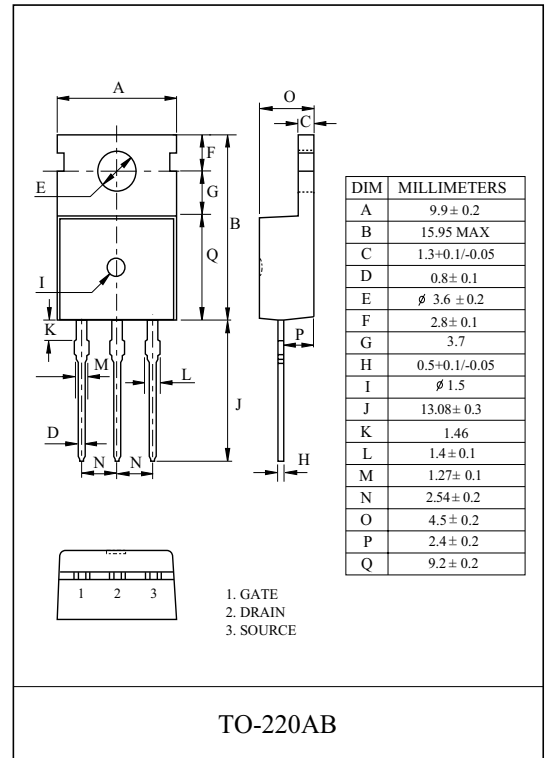
FEATURES

- $V_{DSS} = 600V$, $I_D = 2.0A$
- Drain-Source ON Resistance :
 $R_{DS(ON)} = 5.0 \Omega @ V_{GS} = 10V$
- $Q_g(\text{typ.}) = 10.9nC$

MAXIMUM RATING (Tc=25 °C)

CHARACTERISTIC	SYMBOL	RATING		UNIT	
		KHB2D0N60P1	KHB2D0N60F1		
Drain-Source Voltage	V_{DSS}	600		V	
Gate-Source Voltage	V_{GSS}	± 30		V	
Drain Current	@ $T_C = 25^\circ C$	I_D	2.0	2.0*	A
	@ $T_C = 100^\circ C$		1.2	1.2*	
	Pulsed (Note1)	I_{DP}	8.0	8.0*	
Single Pulsed Avalanche Energy (Note 2)	E_{AS}	120		mJ	
Repetitive Avalanche Energy (Note 1)	E_{AR}	5.4		mJ	
Peak Diode Recovery dv/dt (Note 3)	dv/dt	5.5		V/ns	
Drain Power Dissipation	$T_C = 25^\circ C$	P_D	54	23	W
	Derate above 25 °C		0.43	0.18	
Maximum Junction Temperature	T_j	150		°C	
Storage Temperature Range	T_{stg}	-55 ~ 150		°C	
Thermal Characteristics					
Thermal Resistance, Junction-to-Case	R_{thJC}	2.32	5.5	°C/W	
Thermal Resistance, Case-to-Sink	R_{thCS}	0.5	-	°C/W	
Thermal Resistance, Junction-to-Ambient	R_{thJA}	62.5	62.5	°C/W	

* : Drain current limited by maximum junction temperature.



KHB2D0N60P1/F1**ELECTRICAL CHARACTERISTICS (Tc=25 °C)**

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Static						
Drain-Source Breakdown Voltage	BV_{DSS}	$I_D=250\mu A, V_{GS}=0V$	600	-	-	V
Breakdown Voltage Temperature Coefficient	$\Delta BV_{DSS}/\Delta T_j$	$I_D=250\mu A$, Referenced to 25 °C	-	0.65	-	V/°C
Drain Cut-off Current	I_{DSS}	$V_{DS}=600V, V_{GS}=0V$,	-	-	10	μA
Gate Threshold Voltage	V_{th}	$V_{DS}=V_{GS}, I_D=250\mu A$	2.0	-	4.0	V
Gate Leakage Current	I_{GSS}	$V_{GS}=\pm 30V, V_{DS}=0V$	-	-	± 100	nA
Drain-Source ON Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=1.0A$	-	3.8	5.0	Ω
Dynamic						
Total Gate Charge	Q_g	$V_{DS}=480V, I_D=2.0A$ $V_{GS}=10V$ (Note4,5)	-	10.9	12	nC
Gate-Source Charge	Q_{gs}		-	1.7	3	
Gate-Drain Charge	Q_{gd}		-	5.0	5.5	
Turn-on Delay time	$t_{d(on)}$	$V_{DD}=300V$ $R_L=150\Omega$ $R_G=25\Omega$ (Note4,5)	-	-	28	ns
Turn-on Rise time	t_r		-	-	60	
Turn-off Delay time	$t_{d(off)}$		-	-	58	
Turn-off Fall time	t_f		-	-	66	
Input Capacitance	C_{iss}	$V_{DS}=25V, V_{GS}=0V, f=1.0MHz$	-	388	504	pF
Reverse Transfer Capacitance	C_{riss}		-	6.5	8.5	
Output Capacitance	C_{oss}		-	46	59.4	
Source-Drain Diode Ratings						
Continuous Source Current	I_S	$V_{GS}<V_{th}$	-	-	2.0	A
Pulsed Source Current	I_{SP}		-	-	8.0	
Diode Forward Voltage	V_{SD}	$I_S=2.0A, V_{GS}=0V$	-	-	1.5	V
Reverse Recovery Time	t_{rr}	$I_S=2.0A, V_{GS}=0V$, $dI_S/dt=100A/\mu s$	-	300	-	ns
Reverse Recovery Charge	Q_{rr}		-	1.55	-	μC

Note 1) Repetivity rating : Pulse width limited by junction temperature.

Note 2) $L = 36.9mH, I_S = 2.0A, V_{DD} = 50V, R_G = 25\Omega$, Starting $T_j = 25\text{ }^\circ\text{C}$.

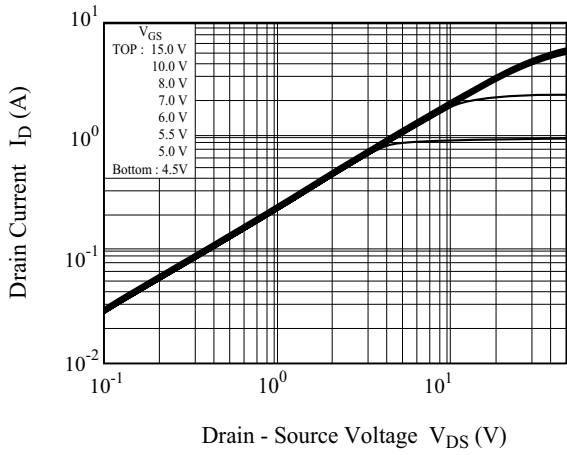
Note 3) $I_S \leq 2.0A, dI/dt \leq 300A/\mu s, V_{DD} \leq BV_{DSS}$, Starting $T_j = 25\text{ }^\circ\text{C}$.

Note 4) Pulse Test : Pulse width $\leq 300\mu s$, Duty Cycle $\leq 2\%$.

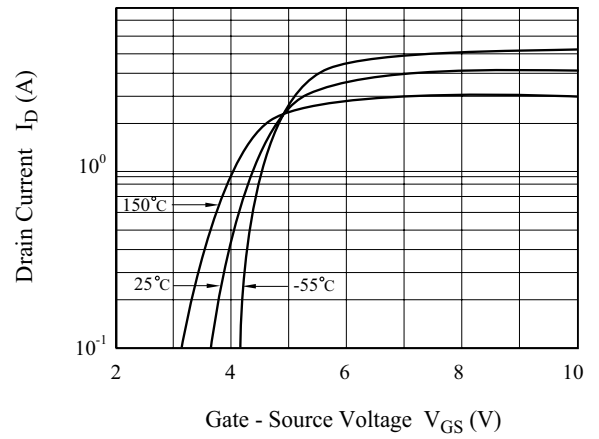
Note 5) Essentially independent of operating temperature.

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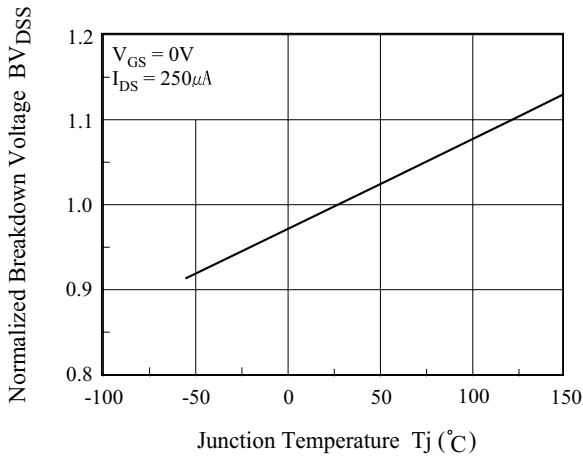
$I_D - V_{DS}$



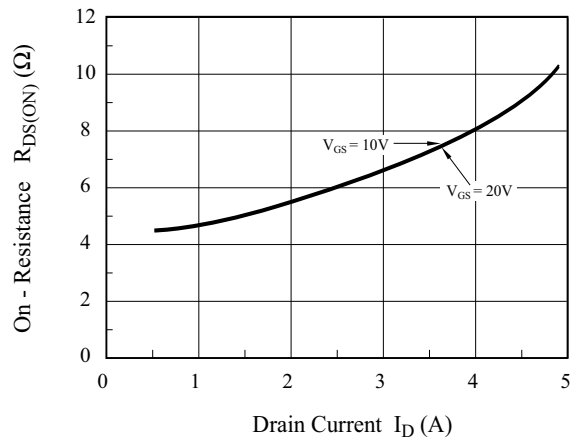
$I_D - V_{GS}$



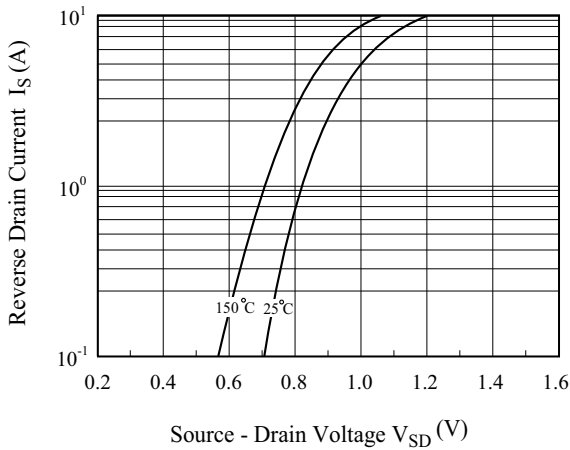
$BV_{DSS} - T_j$



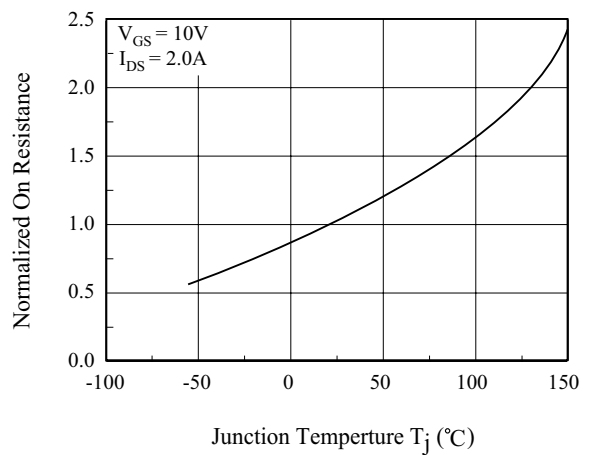
$R_{DS(ON)} - I_D$



$I_S - V_{SD}$

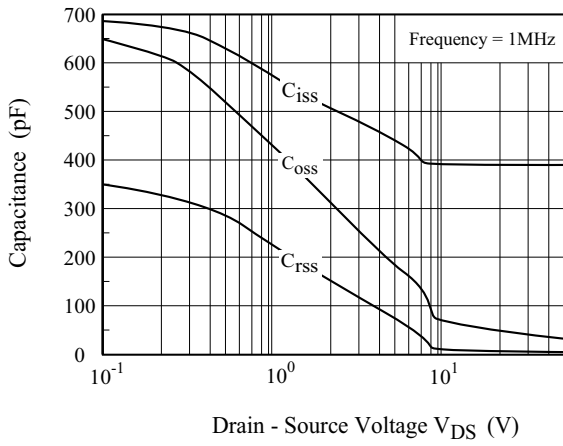


$R_{DS(ON)} - T_j$

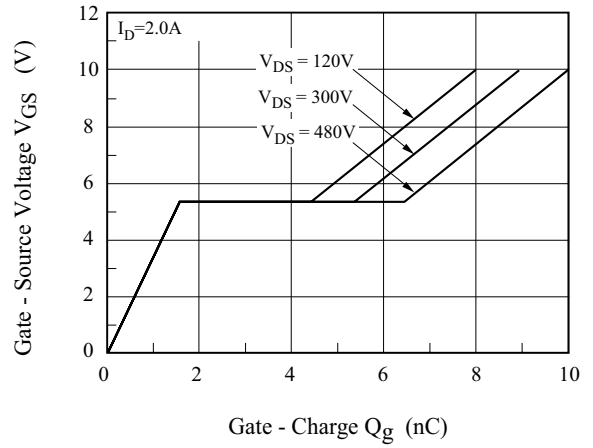


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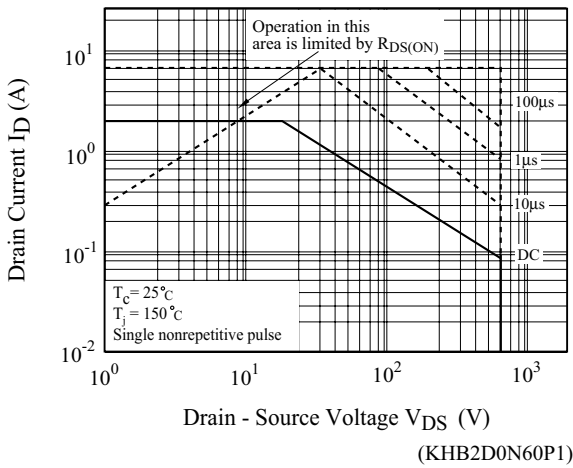
C - V_{DS}



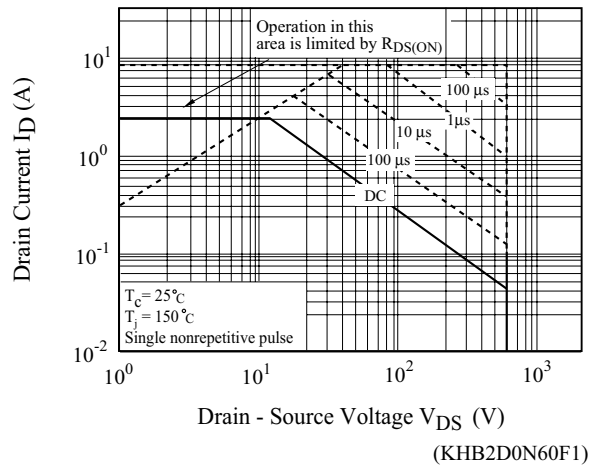
Q_g - V_{GS}



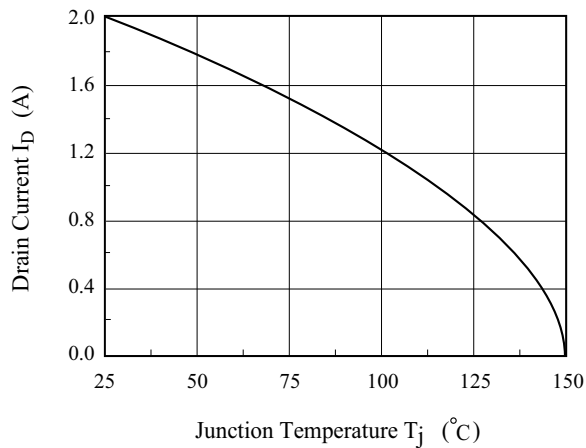
Safe Operation Area



Safe Operation Area



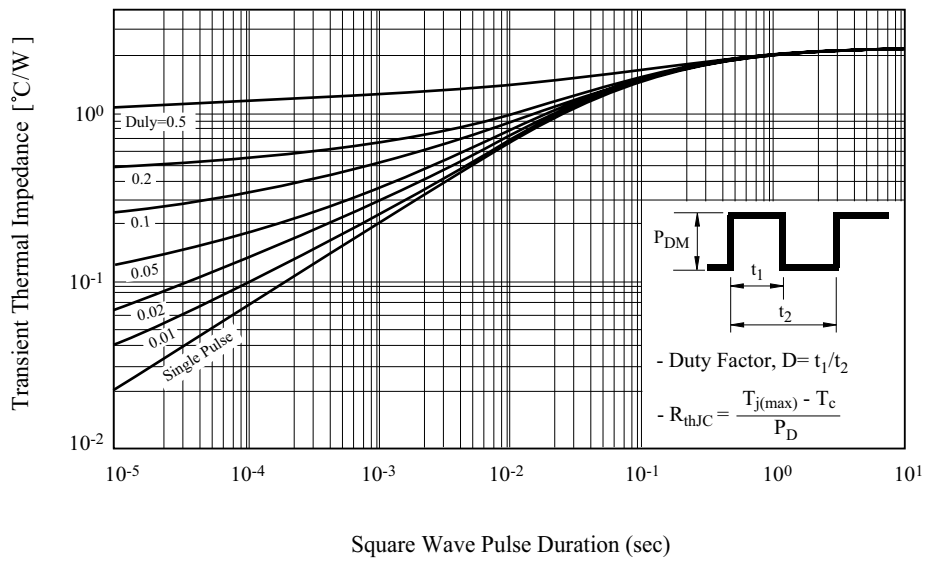
I_D - T_j



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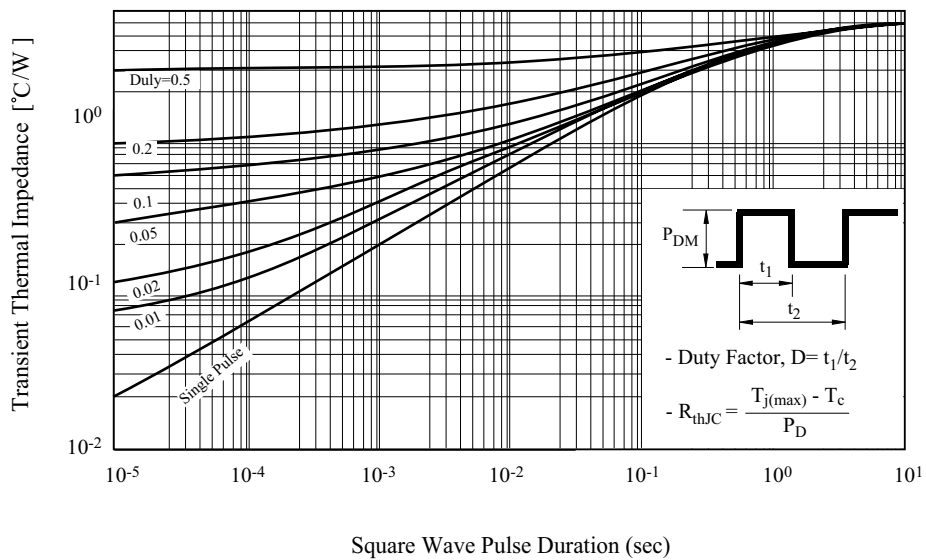
Transient Thermal Impedance

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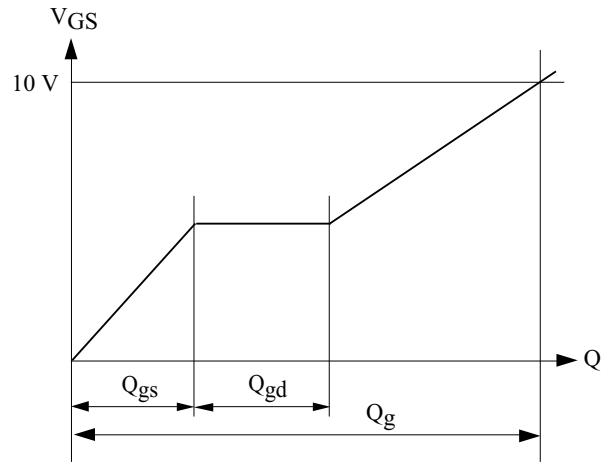
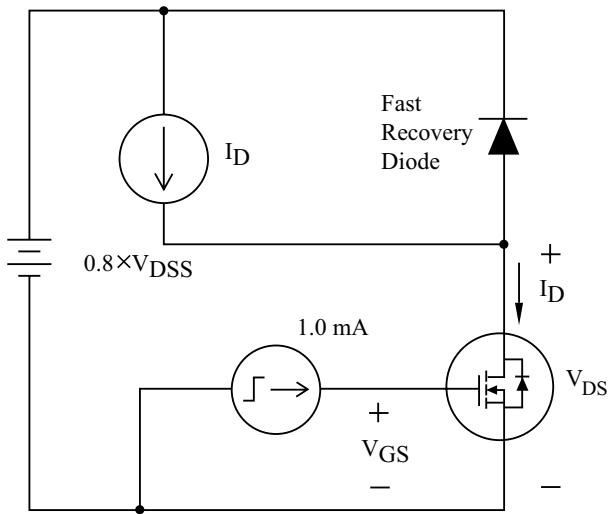
Transient Thermal Impedance

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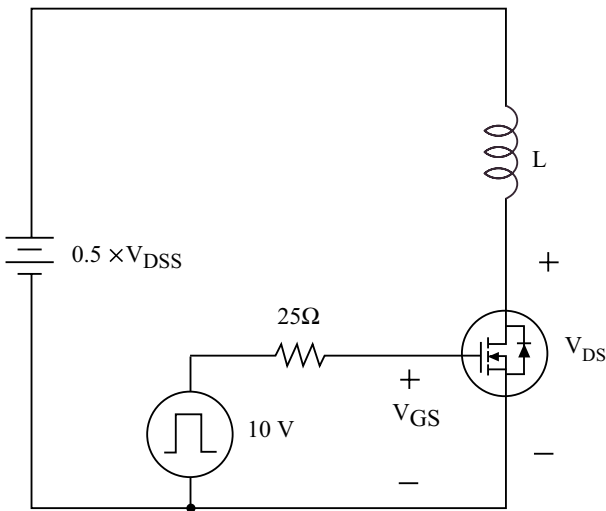


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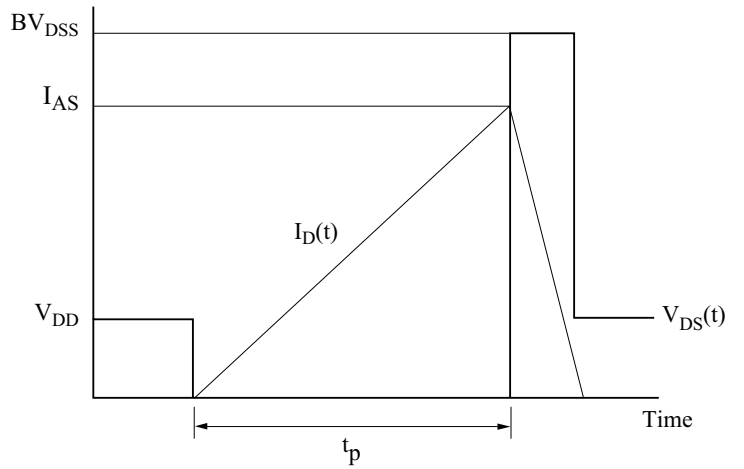
- Gate Charge



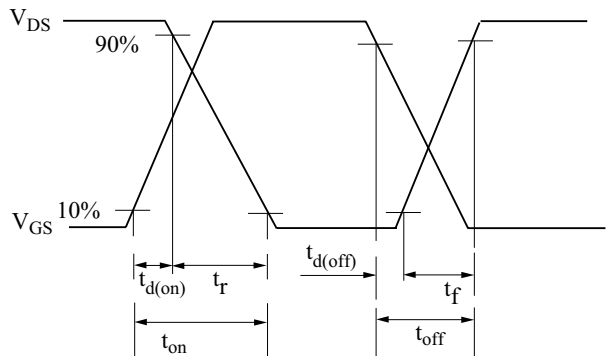
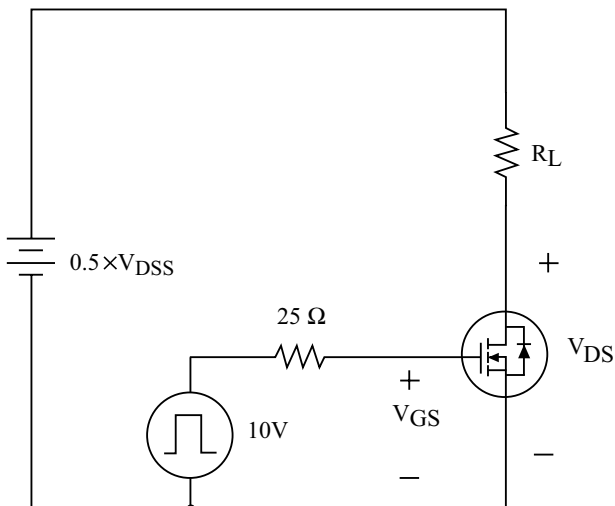
- Single Pulsed Avalanche Energy



$$E_{AS} = \frac{1}{2} L I_{AS}^2 \frac{BV_{DSS}}{BV_{DSS} - V_{DD}}$$



- Resistive Load Switching



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- Source - Drain Diode Reverse Recovery and dv/dt

